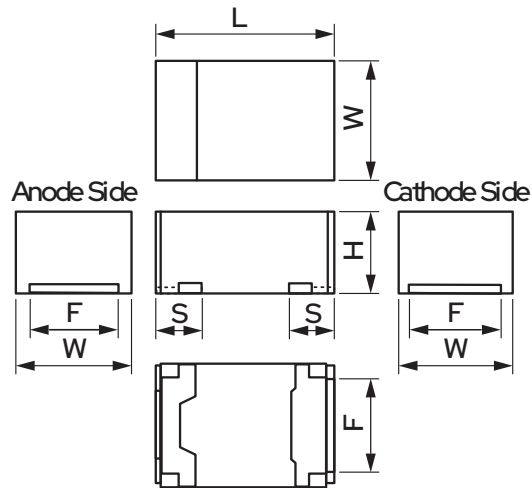


T527T337M2R5APE025

Aliases (TEFPSB30E337M258RKT)

T527, Tantalum, Polymer Tantalum, Reduced Volume, 330 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Face Down Terminals, 25 mOhms, 1.2 mm, 0.7 mm, 1411 / 3528



Click [here](#) for the 3D model.

General Information

Series	T527
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Face Down Terminals
Features	Face Down, Low Profile, Low ESR
RoHS	Yes
Termination	Nickel Palladium Gold
AEC-Q200	No
Typical Component Weight	54.84 mg
Shelf Life	52 Weeks
MSL	3

Dimensions

L	3.5mm +/-0.2mm
W	2.8mm +/-0.2mm
H	1.1mm +/-0.1mm
S	0.7mm +/-0.2mm
F	2.2mm +/-0.1mm

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	3000

Specifications

Capacitance	330 uF
Tolerance	20%
Voltage DC	2.5 VDC (105C)
Temperature Range	-55/+105°C
Rated Temperature	105°C
Life	2000 Hrs (105C)
Humidity	60C, 90% RH, 500 Hours, No Load
Dissipation Factor	10% 120Hz 25C
Failure Rate	N/A
ESR	25 mOhms (100kHz 25C)
Ripple Current	1732 mA (rms, 100kHz 45C), 1212.4 mA (rms, 85C), 433 mA (rms, 105C)
Leakage Current	82.5 uA (5min 25°C)

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